

Updated :	<b>TECHNICAL DATA SHEET</b>
Ref. : DESOXY SP	<b><u>LEAD FREE DEOXIDIZING PASTILLES</u></b>
Created date : 18/07/08	<b>DESOXY SP</b>



## **1 - GENERAL CHARACTERISTICS :**

PASTILLES (about 5 grams), of pure Tin with deoxidizing agent.

## **2 - USE :**

**DESOXYD SP** reduces surface oxidizing on solder bath, in wave soldering machine or any static soldering bath.

### In solder bath or crucible:

For MBO SAC 387, SAC 305, SAC300, Sn99Cu, Sn99CuSP alloys: it depend of the productions, however, than change in oxidizing surface colour permit to decide to add **DESOXYD SP**.

### In solder wave machines:

Add 1 pastille every two solder bars of standard lead free alloy.

Rem: these pastilles can be used with standard leaded alloys too.

## **3 - PACKAGING:**

- Flask of about 200g